



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





MMIC VCO with Half Frequency Output, 8.45 GHz to 9.30 GHz

Data Sheet

HMC1160

FEATURES

Dual output: $f_0 = 8.45 \text{ GHz to } 9.3 \text{ GHz}$

$f_0/2 = 4.225 \text{ GHz to } 4.65 \text{ GHz}$

P_{OUT} : 12 dBm

Phase noise: $-116 \text{ dBc/Hz at } 100 \text{ kHz}$

No external resonator needed

RoHS compliant, 5 mm × 5 mm SMT package: 25 mm²

APPLICATIONS

Point to point and multipoint radio

Test equipment and industrial controls

VSAT

FUNCTIONAL BLOCK DIAGRAM

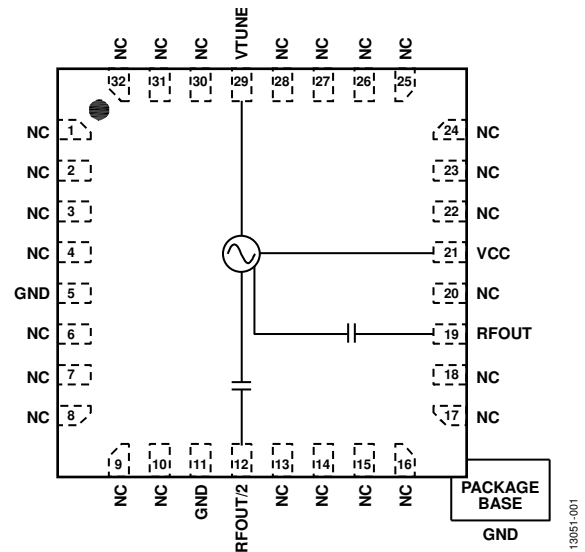


Figure 1.

GENERAL DESCRIPTION

The HMC1160 is a MMIC voltage controlled oscillator that integrates a resonator, a negative resistance device, and a varactor diode, and features a half frequency output.

Because of the monolithic construction of the oscillator, output power and phase noise performance are excellent over temperature.

Power output is 12 dBm typical from a 5 V supply voltage. The voltage controlled oscillator is housed in a RoHS compliant SMT package and requires no external matching components.

Rev. A

[Document Feedback](#)

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781.329.4700 ©2014–2015 Analog Devices, Inc. All rights reserved.

[Technical Support](#)

www.analog.com

HMC1160* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

- EV1HMC1160LP5 Evaluation Board

DOCUMENTATION

Data Sheet

- HMC1160: MMIC VCO with Half Frequency Output, 8.45 GHz to 9.30 GHz Data Sheet

REFERENCE MATERIALS

Quality Documentation

- Package/Assembly Qualification Test Report: LP3, LP4, LP5 & LP5G (QTR: 2014-00145)

DESIGN RESOURCES

- HMC1160 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC1160 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

Submit feedback for this data sheet.

TABLE OF CONTENTS

| | | | |
|--|---|---|----|
| Features | 1 | Interface Schematics | 6 |
| Applications | 1 | Typical Performance Characteristics | 7 |
| Functional Block Diagram | 1 | Evaluation Printed Circuit Board (PCB)..... | 9 |
| General Description | 1 | Bill of Materials..... | 9 |
| Revision History | 2 | Packaging and Ordering Information | 10 |
| Specifications..... | 3 | Outline Dimensions | 10 |
| Absolute Maximum Ratings | 4 | Ordering Guide | 10 |
| ESD Caution..... | 4 | | |
| Pin Configuration and Function Descriptions..... | 5 | | |

REVISION HISTORY

5/15—v00.0814 to Rev. A

This Hittite Microwave Products data sheet has been reformatted to meet the styles and standards of Analog Devices, Inc.

| | |
|---|-----------|
| Updated Format..... | Universal |
| Added Interface Schematics Section, Renumbered Figures | |
| Sequentially | 6 |
| Reordered Figure Sequence, Typical Performance | |
| Characteristics Section..... | 7 |
| Deleted Figure: Frequency vs. Tuning Voltage, T = 25°C, | |
| Renumbered Figures Sequentially..... | 7 |
| Deleted Typical Applications Circuit | 9 |
| Changes to Ordering Guide | 11 |

SPECIFICATIONS

$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 5\text{ V}$, unless otherwise noted.

Table 1.

| Parameter | Min | Typ | Max | Unit | Test Conditions/Comments |
|-----------------------------|-------|------|------|-------------------------|---------------------------|
| FREQUENCY | | | | | |
| Range | | | | | |
| f_0 | 8.45 | | 9.3 | GHz | |
| $f_0/2$ | 4.225 | | 4.65 | GHz | |
| Drift Rate | | 0.74 | | MHz/ $^{\circ}\text{C}$ | |
| Pulling | | 4.5 | | MHz p-p | Pulling into a 2.0:1 VSWR |
| Pushing | | 5.5 | | MHz/V | At VTUNE = 5 V |
| POWER OUTPUT | | | | | |
| RFOUT | 9 | | 17 | dBm | |
| RFOUT/2 | 0 | | 8 | dBm | |
| Supply Current (I_{CC}) | | 240 | | mA | $V_{CC} = 4.75\text{ V}$ |
| | 195 | 260 | 325 | mA | $V_{CC} = 5.00\text{ V}$ |
| | | 275 | | mA | $V_{CC} = 5.25\text{ V}$ |
| HARMONICS, SUBHARMONICS | | | | | |
| 1/2 | | 37 | | dBc | |
| Second | | 18 | | dBc | |
| Third | | 30 | | dBc | |
| TUNING | | | | | |
| Voltage (VTUNE) | 2 | | 13 | V | |
| Sensitivity | 40 | | 250 | MHz/V | |
| Tune Port Leakage Current | | | 10 | μA | VTUNE = 13 V |
| OUTPUT RETURN LOSS | | 2 | | dB | |
| SSB PHASE NOISE | | | | | |
| 10 kHz Offset | | -90 | -85 | dBc/Hz | |
| 100 kHz Offset | | -116 | -110 | dBc/Hz | |

ABSOLUTE MAXIMUM RATINGS

Table 2.

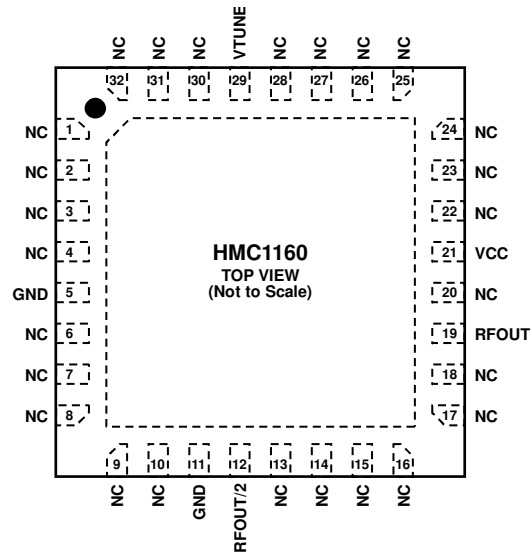
| Parameter | Rating |
|--|-----------------|
| V _{CC} | 5.5 V dc |
| VTUNE | 0 V to 15 V |
| Temperature | |
| Operating | –40°C to +85°C |
| Storage | –65°C to +150°C |
| Nominal Junction (To Maintain 1 million hours MTTF) | 135°C |
| Nominal Junction (T = 85°C) | 125°C |
| Maximum Reflow Temperature (MSL3 Rating) | 260°C |
| Thermal Resistance (Junction to Ground Paddle) | 31°C/W |
| ESD Sensitivity (Human Body Model) | Class 1A |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION**ESD (electrostatic discharge) sensitive device.**

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES

1. NC = NO CONNECT. HOWEVER, THESE PINS MAY BE CONNECTED TO RF/DC GROUND WITHOUT AFFECTING THE PERFORMANCE OF THE DEVICE.
2. THE EXPOSED PAD MUST BE CONNECTED TO RF/DC GROUND.

13051-002

Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
|---|-----------------|---|
| 1 to 4, 6 to 10, 13 to 18, 20, 22 to 28, 30 to 32 | NC | No Connect. However, these pins can be connected to RF/dc ground without affecting the performance of the device. |
| 12 | RFOUT/2 | Half Frequency Output. This pin is ac-coupled. |
| 19 | RFOUT | RF Output. This pin is ac-coupled. |
| 21 | V _{CC} | Supply Voltage (5 V). |
| 29 | VTUNE | Control Voltage and Modulation Input. The modulation bandwidth is dependent on the drive source impedance. |
| 5, 11 | GND | Ground. These pins must be connected to RF/dc ground. |
| | EP | Exposed Paddle. The package bottom has an exposed metal paddle that must be connected to RF/dc ground. |

INTERFACE SCHEMATICS

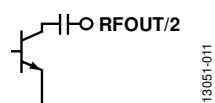


Figure 3. RFOUT/2 Interface

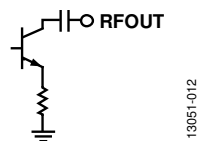


Figure 4. RFOUT Interface

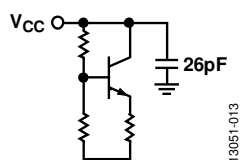


Figure 5. VCC Interface

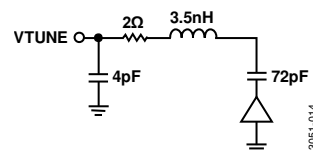


Figure 6. VTUNE Interface

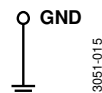


Figure 7. GND Interface

TYPICAL PERFORMANCE CHARACTERISTICS

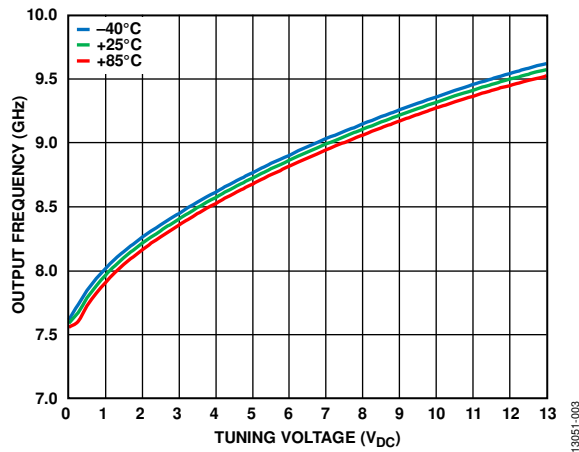


Figure 8. Frequency vs. Tuning Voltage

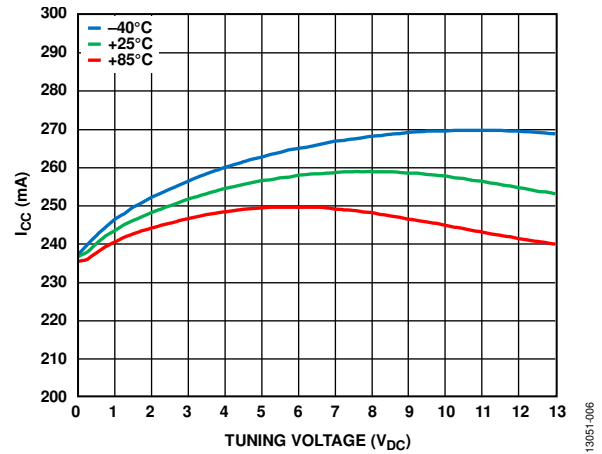
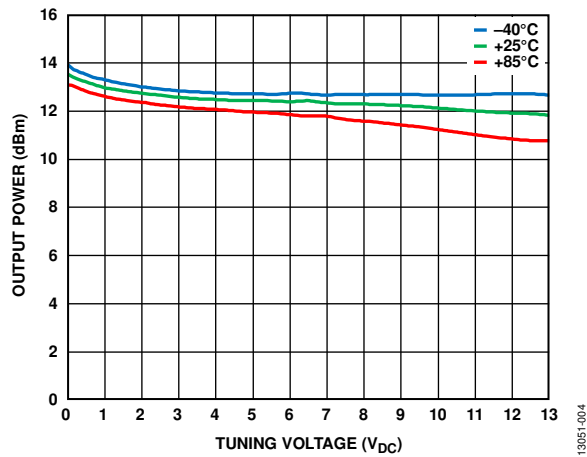
Figure 11. Supply Current (I_{CC}) vs. Tuning Voltage

Figure 9. Output Power vs. Tuning Voltage

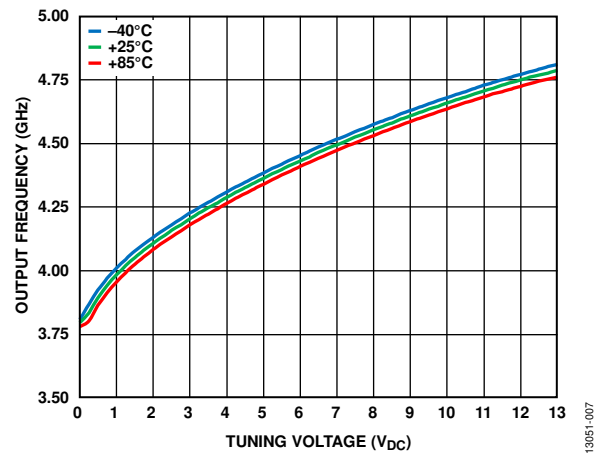


Figure 12. RFOUT/2 Output Frequency vs. Tuning Voltage

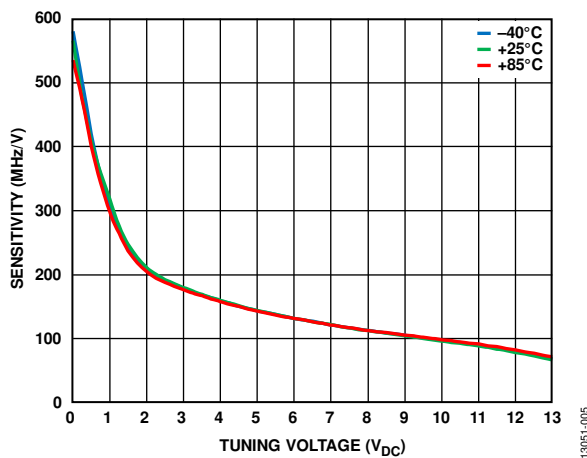


Figure 10. Sensitivity vs. Tuning Voltage

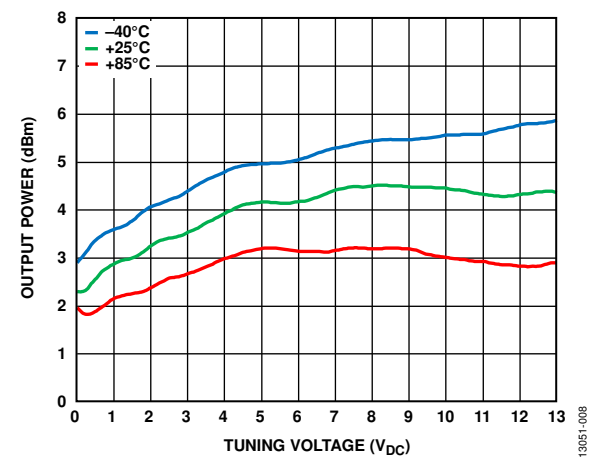


Figure 13. RFOUT/2 Output Power vs. Tuning Voltage

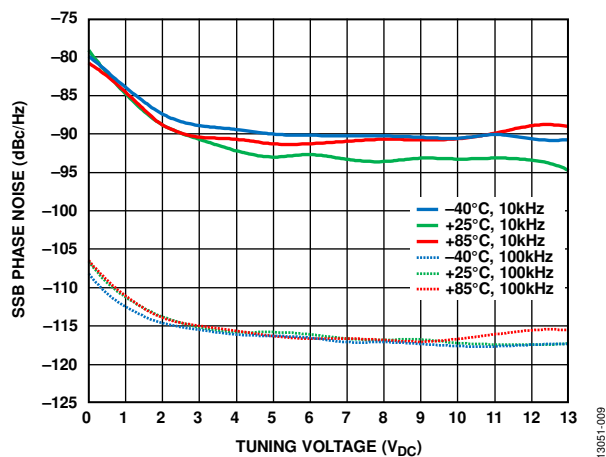


Figure 14. SSB Phase Noise vs. Tuning Voltage

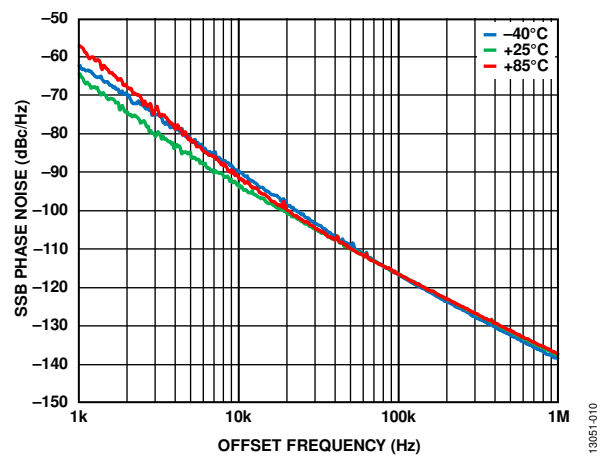


Figure 15. SSB Phase Noise at VTUNE = 5 V

EVALUATION PRINTED CIRCUIT BOARD (PCB)

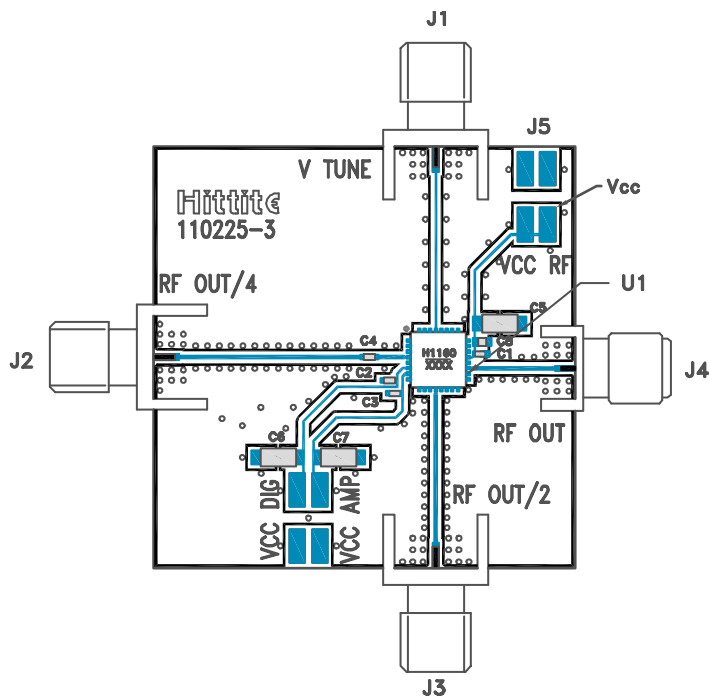


Figure 16. Evaluation Board

The circuit board used in an application uses RF circuit design techniques. Ensure that signal lines have 50 Ω impedance and that the package ground leads and backside ground paddle are connected directly to the ground plane.

Use a sufficient number of via holes to connect the top and bottom ground planes. The evaluation circuit board shown in 16 is available from Analog Devices, Inc., upon request.

BILL OF MATERIALS

Table 4. Bill of Materials EV1HMC1160LP5

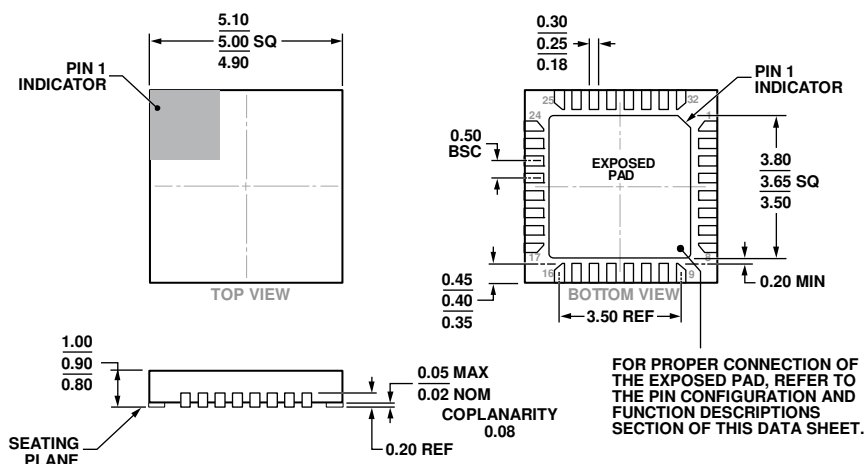
| Item | Description |
|------------------|--------------------------------------|
| J1 to J4 | PCB mount SMA RF connector |
| J5, J6 | 2 mm dc header |
| C1 to C3 | 100 pF capacitor, 0402 package |
| C4 | 1000 pF capacitor, 0402 package |
| C5 to C7 | 2.2 μ F tantalum capacitor |
| C8 | 0.01 μ F capacitor, 0603 package |
| U1 | HMC1160 VCO |
| PCB ¹ | 110225 evaluation board ² |

¹ Circuit board material is Rogers 4350.

² Reference this number when ordering the complete evaluation PCB.

PACKAGING AND ORDERING INFORMATION

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-VHHD-4.

Figure 17. 32-Lead Lead Frame Chip Scale Package [LFCSP_VQ]
5 mm x 5 mm Body, Very Thin Quad
(HCP-32-1)
Dimensions shown in millimeters

ORDERING GUIDE

| Model ¹ | Temperature Range | MSL Rating ² | Package Description | Package Option | Qty. | Brand ³ |
|--------------------|-------------------|-------------------------|------------------------------------|----------------|------|--------------------|
| HMC1160LP5E | -40°C to +85°C | MSL3 | 32-Lead LFCSP_VQ | HCP-32-1 | | H1160 XXXX |
| HMC1160LP5ETR | -40°C to +85°C | MSL3 | 32-Lead LFCSP_VQ, 7" Tape and Reel | HCP-32-1 | 500 | H1160 XXXX |
| EV1HMC1160LP5 | | | Evaluation Board | | | |

¹ The HMC1160LP5E and HMC1160LP5ETR are RoHS compliant parts.

² See the Absolute Maximum Ratings section, Table 2.

³ XXXX is a placeholder for the 4-digit lot number.